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Renesas Electronics website: <http://www.renesas.com>

April 1st, 2010
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (<http://www.renesas.com>)

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MOS FIELD EFFECT TRANSISTOR 2SK2415,2415-Z

SWITCHING N-CHANNEL POWER MOS FET

Description

The 2SK2415 is N-Channel MOS Field Effect Transistor designed for high voltage switching applications.

Features

- Low on-state resistance
 $R_{DS(on)1} = 0.10 \Omega \text{ MAX. (} V_{GS} = 10 \text{ V, } I_D = 4.0 \text{ A)}$
 $R_{DS(on)2} = 0.15 \Omega \text{ MAX. (} V_{GS} = 4 \text{ V, } I_D = 4.0 \text{ A)}$
- Low C_{iss} : $C_{iss} = 570 \text{ pF TYP.}$

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$)

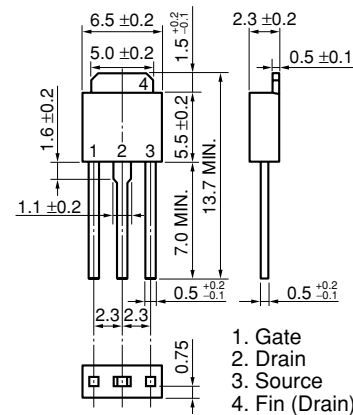
| | | | |
|--|----------------|------------------------|------------------|
| Drain to Source Voltage | V_{DSS} | 60 | V |
| Gate to Source Voltage | V_{GSS} | ± 20 | V |
| Drain Current (DC) | $I_{D(DC)}$ | ± 8.0 | A |
| Drain Current (pulse) Note 1 | $I_{D(pulse)}$ | ± 32 | A |
| Total Power Dissipation ($T_c = 25^\circ\text{C}$) | P_{T1} | 20 | W |
| Total Power Dissipation ($T_A = 25^\circ\text{C}$) | P_{T2} | 1.0 | W |
| Channel Temperature | T_{ch} | 150 | $^\circ\text{C}$ |
| Storage Temperature | T_{stg} | $-55 \text{ to } +150$ | $^\circ\text{C}$ |
| Single Avalanche Current Note 2 | I_{AS} | 8.0 | A |
| Single Avalanche Energy Note 2 | E_{AS} | 6.4 | mJ |

Notes 1 $PW \leq 10 \mu\text{s}$, Duty Cycle $\leq 1\%$

2 Starting $T_{ch} = 25^\circ\text{C}$, $R_G = 25 \Omega$, $V_{GS} = 20 \rightarrow 0 \text{ V}$

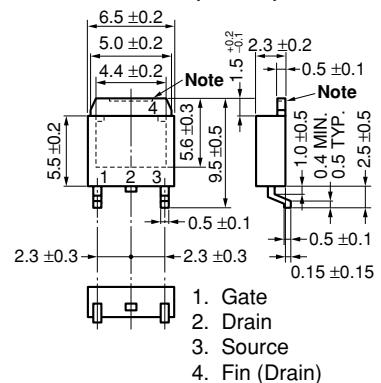
PACKAGE DRAWINGS (Unit: mm)

TO-251 (MP-3)



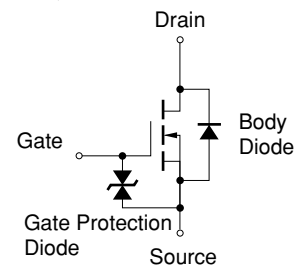
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TO-252 (MP-3Z)



Note The depth of notch at the top of the fin is from 0 to 0.2 mm.

EQUIVALENT CIRCUIT

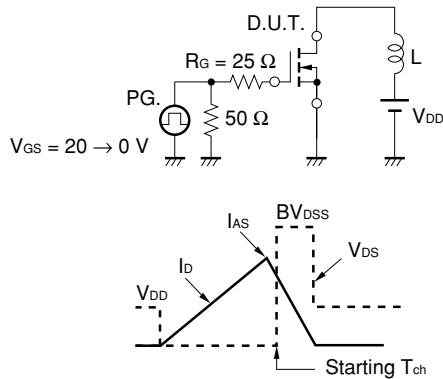


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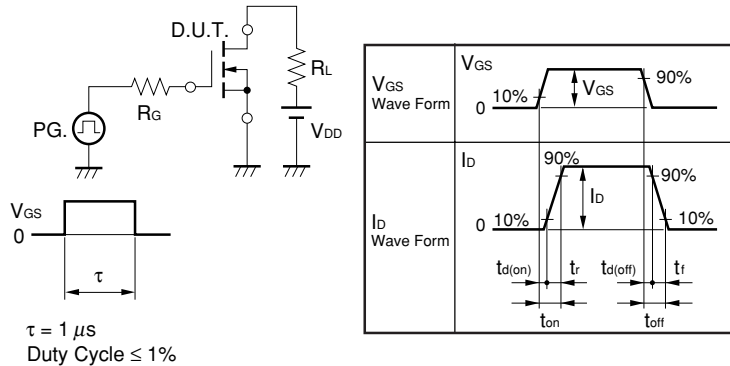
ELECTRICAL CHARACTERISTICS (Ta = 25°C)

| CHARACTERISTIC | SYMBOL | MIN. | TYP. | MAX. | UNIT | TEST CONDITIONS |
|-------------------------------------|---------------|------|------|----------|---------------|---|
| Drain to Source On-state Resistance | $R_{DS(on)1}$ | | 0.07 | 0.10 | Ω | $V_{GS} = 10\text{ V}, I_D = 4.0\text{ A}$ |
| | $R_{DS(on)2}$ | | 0.10 | 0.15 | Ω | $V_{GS} = 4\text{ V}, I_D = 4.0\text{ A}$ |
| Gate Cut-off Voltage | $V_{GS(off)}$ | 1.0 | 1.6 | 2.0 | V | $V_{DS} = 10\text{ V}, I_D = 1\text{ mA}$ |
| Forward Transfer Admittance | $ y_{fs} $ | 5.0 | 8.4 | | S | $V_{DS} = 10\text{ V}, I_D = 4.0\text{ A}$ |
| Zero Gate Voltage Drain Current | I_{DSS} | | | 10 | μA | $V_{DS} = 60\text{ V}, V_{GS} = 0\text{ V}$ |
| Gate Leakage Current | I_{GSS} | | | ± 10 | μA | $V_{GS} = \pm 20\text{ V}, V_{DS} = 0\text{ V}$ |
| Input Capacitance | C_{iss} | | 570 | | pF | $V_{DS} = 10\text{ V}$ |
| Output Capacitance | C_{oss} | | 290 | | pF | $V_{GS} = 0\text{ V}$ |
| Reverse Transfer Capacitance | C_{rss} | | 75 | | pF | $f = 1\text{ MHz}$ |
| Turn-On Delay Time | $t_{d(on)}$ | | 5 | | ns | $I_D = 4.0\text{ A}$ |
| Rise Time | t_r | | 60 | | ns | $V_{GS} = 10\text{ V}$ |
| Turn-Off Delay Time | $t_{d(off)}$ | | 75 | | ns | $V_{DD} = 30\text{ V}$ |
| Fall Time | t_f | | 40 | | ns | $R_G = 10\ \Omega$ |
| Total Gate Charge | Q_G | | 21 | | nC | $I_D = 8.0\text{ A}$ |
| Gate to Source Charge | Q_{GS} | | 2.0 | | nC | $V_{DD} = 48\text{ V}$ |
| Gate to Drain Charge | Q_{GD} | | 6.5 | | nC | $V_{GS} = 10\text{ V}$ |
| Body Diode Forward Voltage | $V_{F(S-D)}$ | | 1.0 | | V | $I_F = 8.0\text{ A}, V_{GS} = 0\text{ V}$ |
| Reverse Recovery Time | t_{rr} | | 85 | | ns | $I_F = 8.0\text{ A}, V_{GS} = 0\text{ V}$ |
| Reverse Recovery Charge | Q_{rr} | | 200 | | nC | $di/dt = 100\text{ A}/\mu\text{s}$ |

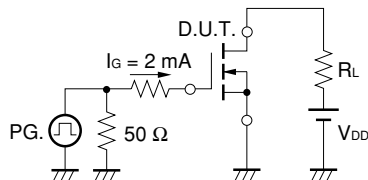
TEST CIRCUIT 1 AVALANCHE CAPABILITY



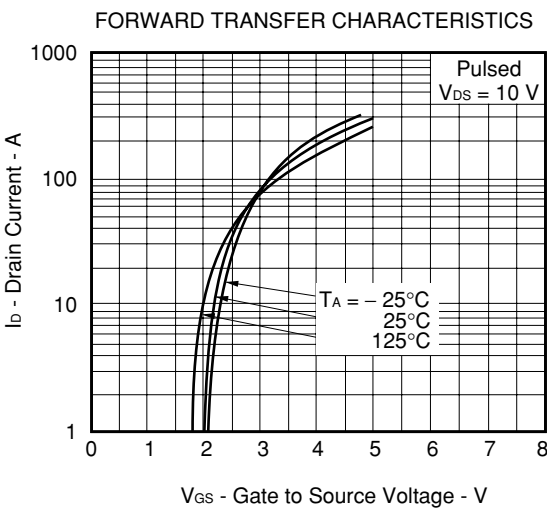
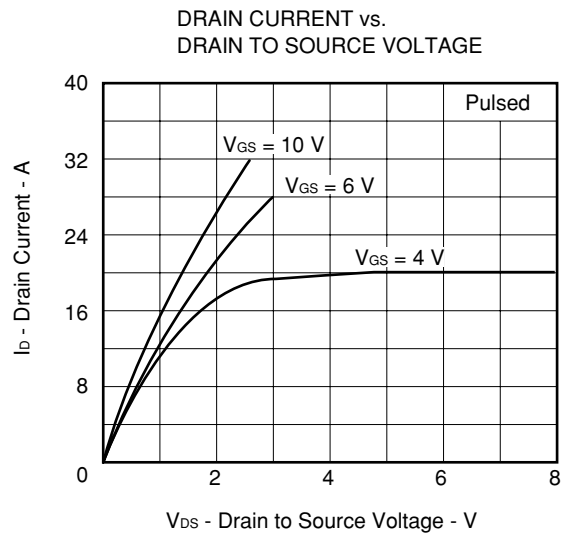
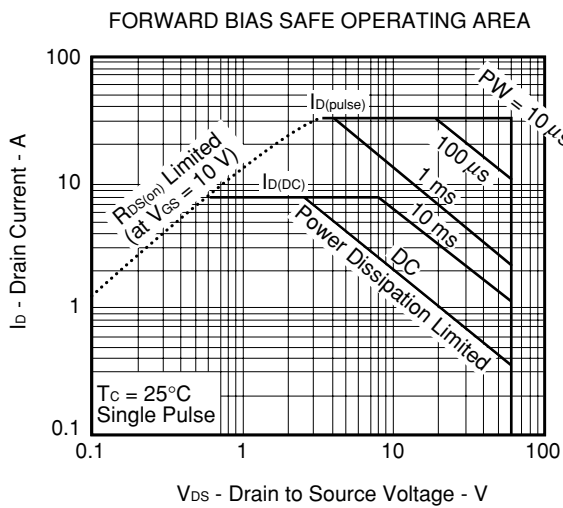
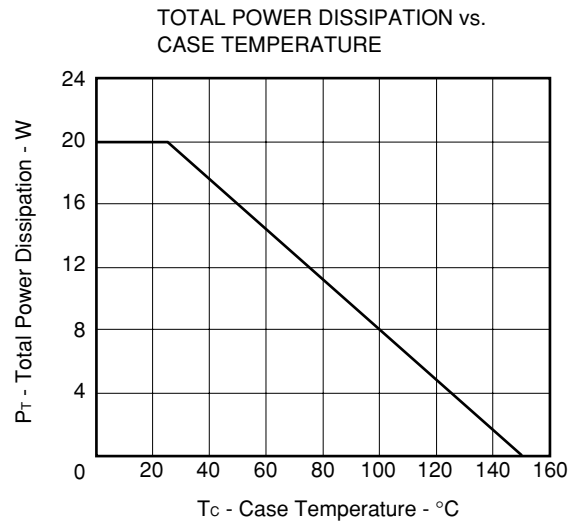
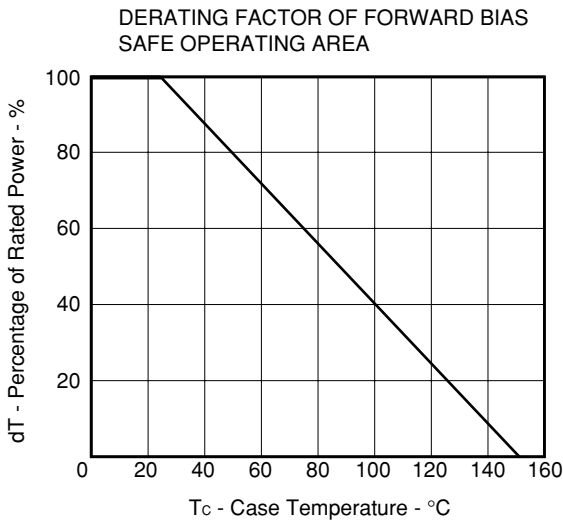
TEST CIRCUIT 2 SWITCHING TIME



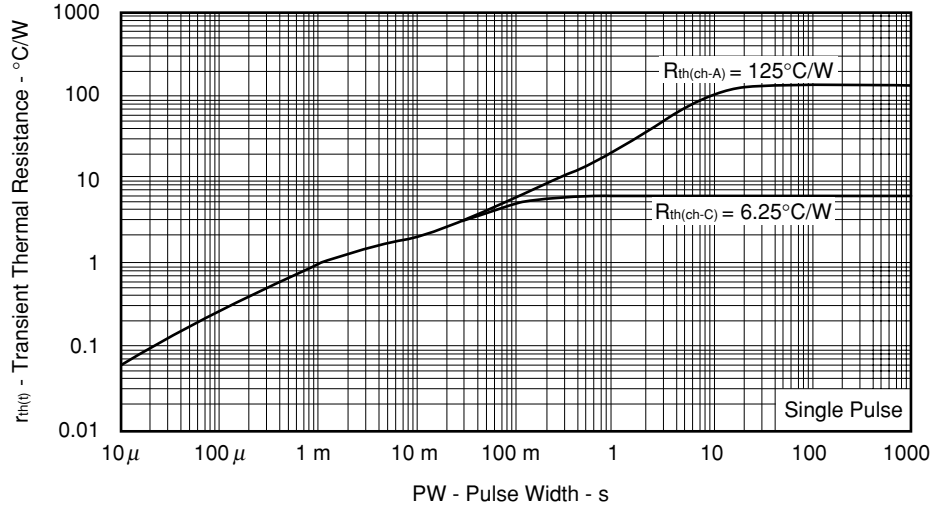
TEST CIRCUIT 3 GATE CHARGE



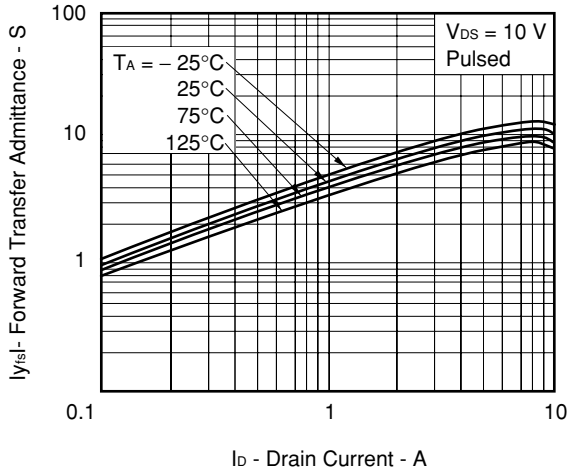
TYPICAL CHARACTERISTICS (T_A = 25 °C)



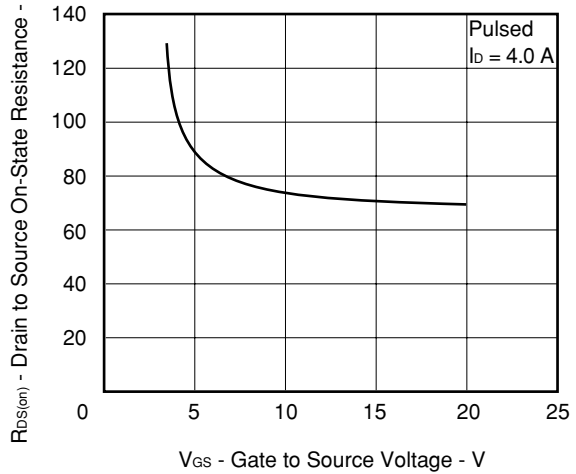
TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



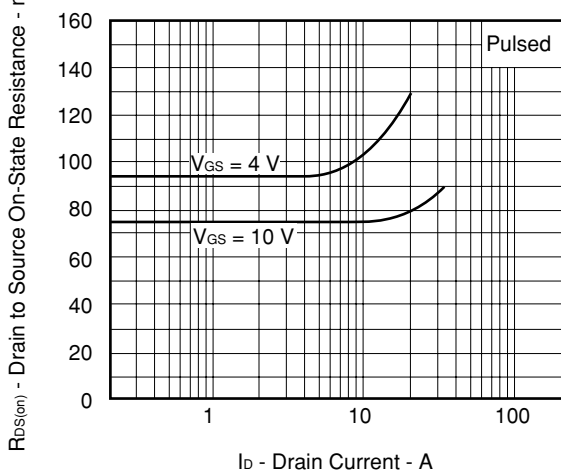
FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



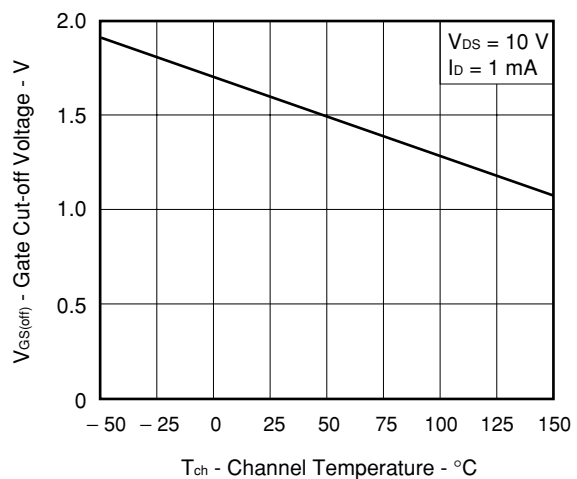
DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE

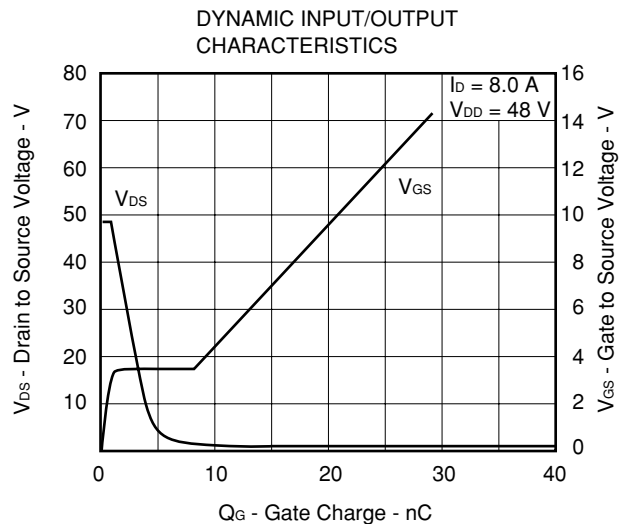
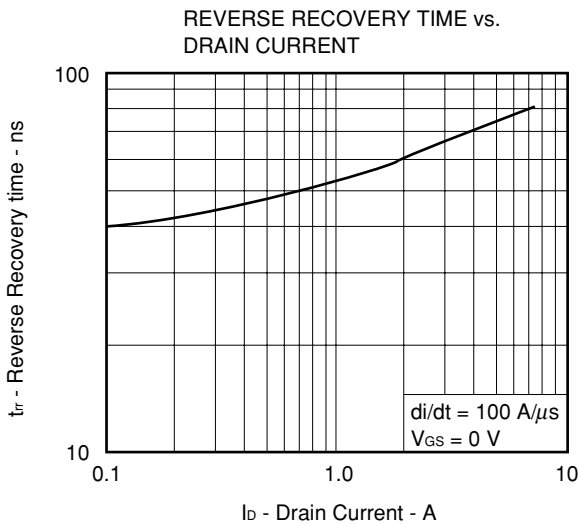
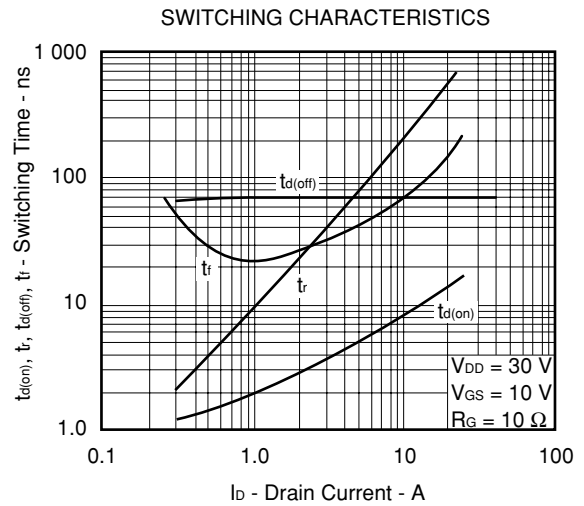
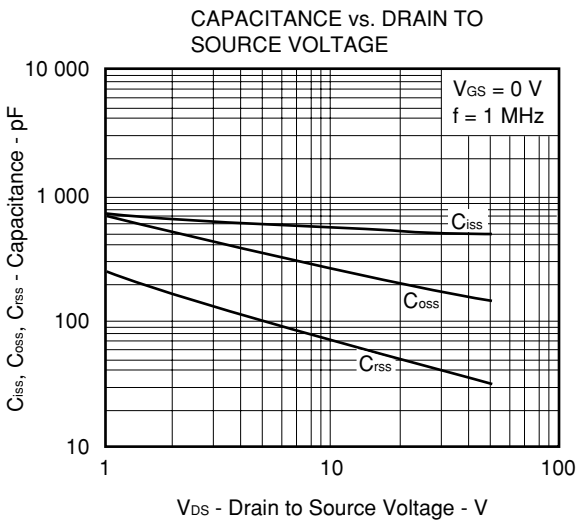
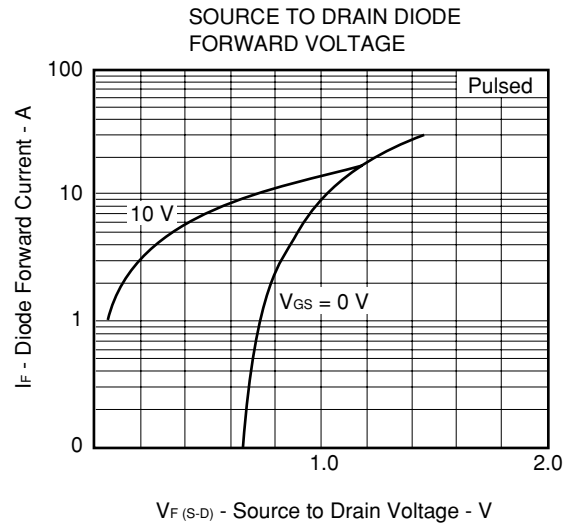
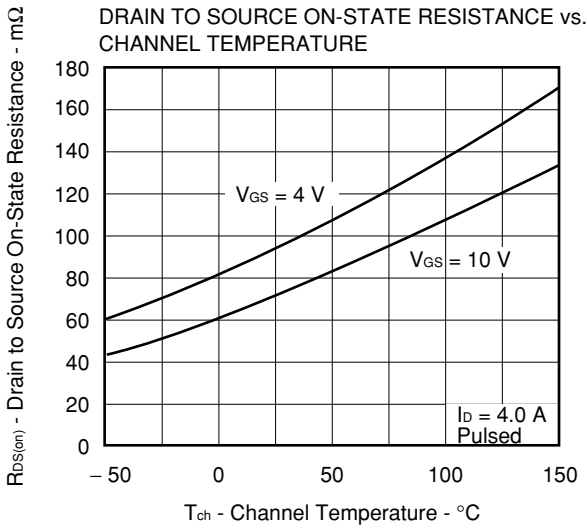


DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT

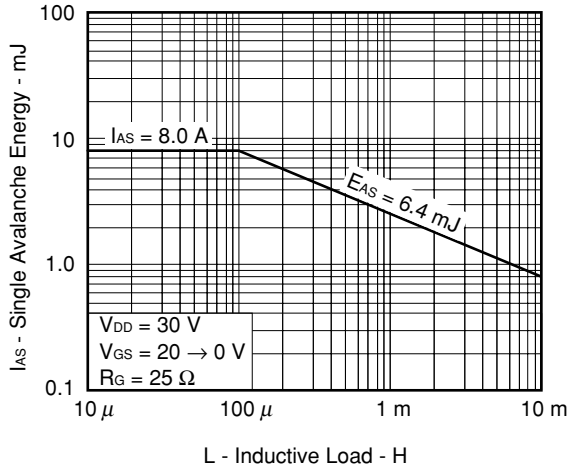


GATE CUT-OFF VOLTAGE vs. CHANNEL TEMPERATURE

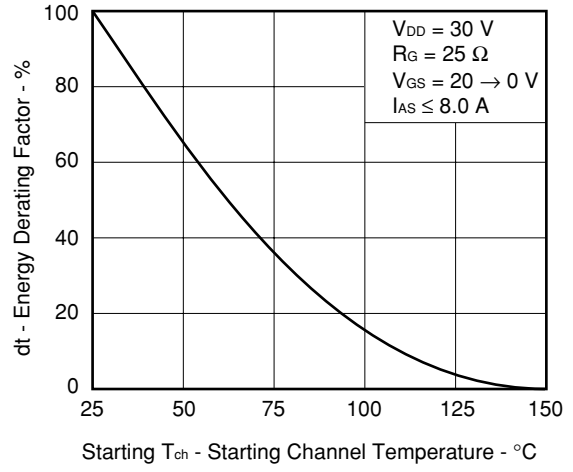




SINGLE AVALANCHE ENERGY vs. INDUCTIVE LOAD



SINGLE AVALANCHE ENERGY DERATING FACTOR



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